

Data Sheet July 2001 File Number 9001.2

# Single Event Radiation Hardened High Speed, Current Mode PWM



The IS-1845ASRH is designed to be used in switching power supplies operating in current-mode. The rising edge of the on-chip oscillator

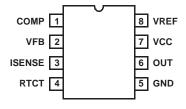
turns on the output. Turn-off is controlled by the current sense comparator and occurs when the sensed current reaches a peak controlled by the error amplifier. The error amplifier output is the difference between the sampled voltage and  $V_{\rm RFF}$ .

Constructed with Intersil's Rad Hard Silicon Gate (RSG) dielectrically isolated BiCMOS process, these devices are immune to single event latch-up and have been specifically designed to provide a high level of immunity to single event transients. All specified parameters are guaranteed and tested for 300krad(Si) total dose performance.

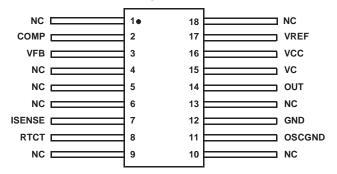
Detailed Electrical Specifications for these devices are contained in SMD 5962-01509. A "hot-link" is provided on our homepage for downloading the SMD. www.intersil.com/spacedefense/spacenewprod.asp

## **Pinout**

# IS7-1845ASRH (CDIP2-T8 SBDIP) TOP VIEW



# IS9-1845ASRH (FLATPACK) TOP VIEW



NOTE: Grounding the Comp pin does not inhibit the output. The output may be inhibited by applying >1.2V to the ISENSE pin.

#### **Features**

- Electrically Screened to DSCC SMD # 5962-01509
- QML Qualified per MIL-PRF-38535 Requirements
- Radiation Environment

	<ul> <li>Total Dose</li></ul>
•	Low Start-up Current
•	Fast Propagational Delay 80ns (Typ)
•	Supply Voltage Range
•	High Output Drive
•	Under Voltage Lockout 8.8V Start (Typ), 8.2V Stop (Typ)

- 2.5V Voltage Reference (VREF)
- · Switching Frequencies to 500kHz

# **Applications**

- · Current-Mode Switching Power Supplies
- · Control of High Current FET Drivers
- · Motor Speed and Direction Control

# Ordering Information

ORDERING NUMBER	INTERNAL MKT. NUMBER	TEMP. RANGE (°C)
5962F0150901VPC	IS7-1845ASRH-Q	-50 to 125
5962F0150901QPC	IS7-1845ASRH-8	-50 to 125
5962F0150901VXC	IS9-1845ASRH-Q	-50 to 125
5962F0150901QXC	IS9-1845ASRH-8	-50 to 125
IS7-1845ASRH/Proto	IS1-1845ASRH/Proto	-50 to 125
IS9-1845ASRH/Proto	IS9-1845ASRH/Proto	-50 to 125

## Die Characteristics

#### **DIE DIMENSIONS**

 $3090\mu m$  x  $4080\mu m$  (121.6 mils x 159.0 mils) Thickness:  $483\mu m \pm 25.4\mu m$  (19 mils  $\pm$  1 mil)

#### **INTERFACE MATERIALS**

#### Glassivation

Type: Phosphorus Silicon Glass (PSG)

Thickness: 8.0kA ± 1.0kA

## **Top Metallization**

Type: AlSiCu

Thickness: 16.0kA ± 2kA

#### Substrate

Radiation Hardened Silicon Gate,

Dielectric Isolation

#### **Backside Finish**

Silicon

#### ASSEMBLY RELATED INFORMATION

#### **Substrate Potential**

Unbiased (DI)

### ADDITIONAL INFORMATION

**Worst Case Current Density** 

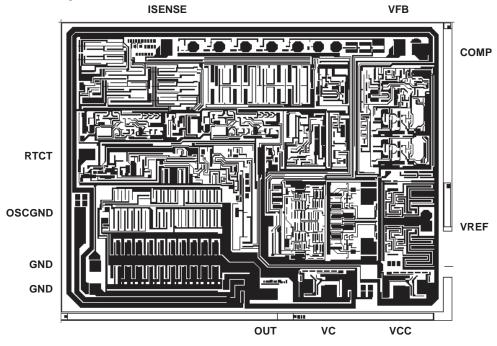
 $<2.0 \times 10^{5} \text{ A/cm}^{2}$ 

#### **Transistor Count**

582

# Metallization Mask Layout

IS-1845ASRH



#### NOTES:

- 1. Both the GND pads must be bonded to ground.
- 2. The OUT double-sized bond pad must be double bonded for current sharing purposes.
- 3. The OSCGND double-sized bond pad must be double bonded to ground for current sharing purposes.

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